

February 2007

FDB8447L 40V N-Channel PowerTrench MOSFET 40V, 50A, $8.5 m\Omega$

Features

- Max $r_{DS(on)}$ = 8.5m Ω at V_{GS} = 10V, I_D = 14A
- Max $r_{DS(on)}$ = 11m Ω at V_{GS} = 4.5V, I_D = 11A
- Fast Switching
- RoHS Compliant

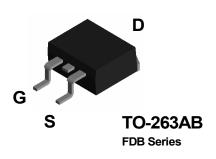


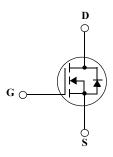
General Description

This N-Channel MOSFET has been produced using Fairchild Semiconductor's proprietary PowerTrench technology to deliver low $r_{DS(on)}$ and optimized BV_{DSS} capability to offer superior performance benefit in the application.

Application

- Inverter
- Power Supplies





MOSFET Maximum Ratings $T_C = 25$ °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V_{DS}	Drain to Source Voltage			40	V	
V_{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous (Package limited)	T _C = 25°C		50		
	-Continuous (Silicon limited)	T _C = 25°C	(Note 1)	66		
ID D	-Continuous	T _A = 25°C	(Note 1a)	15	A	
	-Pulsed			100		
E _{AS}	Drain-Source Avalanche Energy		(Note 3)	153	mJ	
В	Power Dissipation	T _C = 25°C		60	W	
P_{D}	Power Dissipation		(Note 1a)	3.1	VV	
T _J , T _{STG}	Operating and Storage Junction Temperature Range	e		-55 to +150	°C	

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	(Note 1)	2.1	°C/W
R _{e.IA}	Thermal Resistance, Junction to Ambient	(Note 1a)	40	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB8447L	FDB8447L	TO-263AB	330mm	24mm	800 units

Electrical Characteristics $T_J = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV_{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	40			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I _D = 250μA, referenced to 25°C		35		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 32V, V_{GS} = 0V$			1	μΑ
I_{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V$, $V_{GS} = 0V$			±100	nA

On Characteristics (Note 2)

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	1	1.9	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 μ A, referenced to 25°C		-5		mV/°C
		V _{GS} = 10V, I _D = 14A		7.4	8.5	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 4.5V, I_D = 11A$		8.7	11.0	mΩ
	V _{GS} = 10V, I _D = 14A, T _J =125°C		10.8	12.4		
g_{FS}	Forward Transconductance	V _{DS} = 5V, I _D = 14A		58		S

Dynamic Characteristics

C _{iss}	Input Capacitance	V = 20V V = 0V	1970	2620	pF
C _{oss}	Output Capacitance	V _{DS} = 20V, V _{GS} = 0V, f = 1MHz	250	335	pF
C _{rss}	Reverse Transfer Capacitance	1 - 11/11/2	150	225	pF
R_g	Gate Resistance	f = 1MHz	1.0		Ω

Switching Characteristics

t _{d(on)}	Turn-On Delay Time		11	20	ns
t _r	Rise Time	$V_{DD} = 20V, I_{D} = 14A$ $V_{GS} = 10V, R_{GEN} = 6\Omega$	6	12	ns
t _{d(off)}	Turn-Off Delay Time		28	45	ns
t _f	Fall Time		4	10	ns
$Q_{g(TOT)}$	Total Gate Charge, V _{GS} = 10V		37	52	nC
$Q_{g(TOT)}$	Total Gate Charge, V _{GS} = 5V	V_{DD} =20V, I_{D} = 14A V_{GS} = 10V	20	28	nC
Q_{gs}	Gate to Source Gate Charge	V _{GS} - 10V	6		nC
Q_{gd}	Gate to Drain "Miller" Charge		7		nC

Drain-Source Diode Characteristics

V_{SD}	Source to Drain Diode Forward Voltage	V _{GS} = 0V, I _S = 14A (Note 2)		0.8	1.2	V
t _{rr}	Reverse Recovery Time	I _F = 14A, di/dt = 100A/μs		28	42	ns
Q _{rr}	Reverse Recovery Charge			24	36	nC

Notes

Re_{0.0.C} is guaranteed by design while R_{0.0.C} is determined by the user's board design.

a. 40°C/W when mounted on a 1 in² pad of 2 oz copper

b. 62.5°C/W when mounted on a minimum pad.

^{2:} Pulse Test: Pulse Width < 300μ s, Duty cycle < 2.0%.

^{3:} Starting $T_J = 25$ °C, L = 1mH, $I_{AS} = 17.5$ A, $V_{DD} = 40$ V, $V_{GS} = 10$ V.

Typical Characteristics T_J = 25°C unless otherwise noted

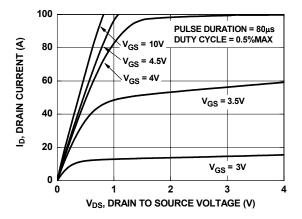


Figure 1. On Region Characteristics

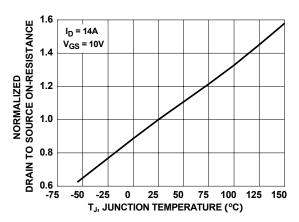


Figure 3. Normalized On Resistance vs Junction Temperature

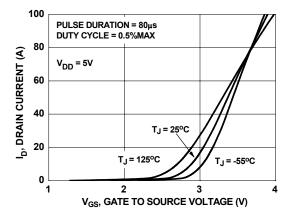


Figure 5. Transfer Characteristics

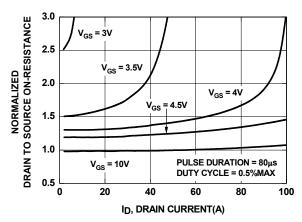


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

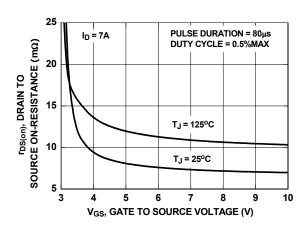


Figure 4. On-Resistance vs Gate to Source Voltage

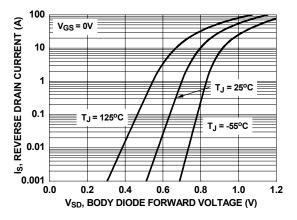


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

Typical Characteristics $T_J = 25^{\circ}C$ unless otherwise noted

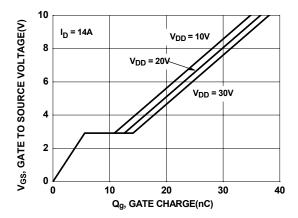


Figure 7. Gate Charge Characteristics

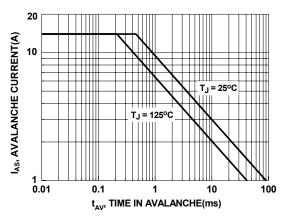


Figure 9. Unclamped Inductive Switching Capability

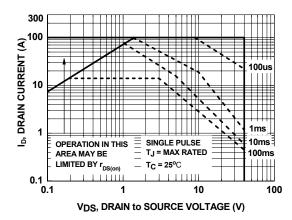


Figure 11. Forward Bias Safe Operating Area

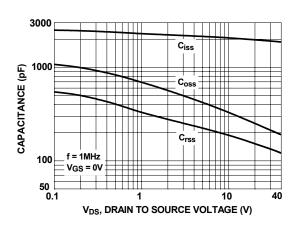


Figure 8. Capacitance vs Drain to Source Voltage

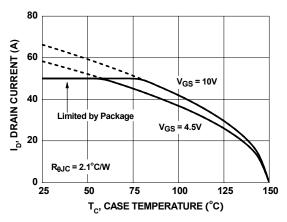


Figure 10. Maximum Continuous Drain Current vs Case Temperature

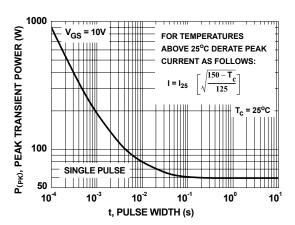


Figure 12. Single Pulse Maximum Power Dissipation

Typical Characteristics T_J = 25°C unless otherwise noted

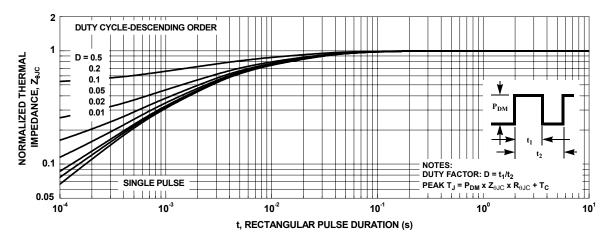


Figure 13. Transient Thermal Response Curve





TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

$ACEx^{\mathbb{R}}$	GTO^{TM}	PowerSaver TM	TinyBuck TM
Across the board. Around the world.™	HiSeC TM	PowerTrench [®]	TinyLogic [®]
ActiveArray TM	i-Lo™	Programmable Active Droop TM	TINYOPTOTM
Bottomless TM	ImpliedDisconnect™	QFET [®]	TinyPower TM
Build it Now TM	IntelliMAX TM	QS^{TM}	TinyWire TM
CoolFETTM	ISOPLANAR™	QT Optoelectronics TM	TruTranslation™
$CROSSVOLT^{TM}$	MICROCOUPLER™	Quiet Series TM	μSerDes™
CTL TM	MicroPak TM	RapidConfigure™	UHC^{\circledR}
Current Transfer Logic TM	MICROWIRE TM	RapidConnect™	UniFET TM
DOMETM	MSX™	ScalarPump™	VCX TM
E^2CMOS^{TM}	MSXPro™	SMART START TM	Wire TM
EcoSPARK TM	OCX^{TM}	SPM TM	
EnSigna™	OCXPro™	SuperFET TM	
FACT Quiet Series™	OPTOLOGIC [®]	SuperSOTTM-3	
$FACT^{@}$	OPTOPLANAR™	SuperSOTTM-6	
FAST [®]	PACMANTM	SuperSOTTM-8	

РОРТМ **FPSTM** Power220® The Power Franchise®

FRFET® Power247® (I)TM PowerEdgeTM TinyBoostTM GlobalOptoisolatorTM

DISCLAIMER

 $FASTr^{TM}$

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN, FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

ТСМтм

LIFE SUPPORT POLICY

EIFE SUFFORT FOLIC!
FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.

2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild Semiconductor. The datasheet is printed for reference information only.

Rev. I23

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

FDB8447L